



# Design of reconfigurable on-chip wireless interconnections through Optical Phased Arrays

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**Abstract:** In this paper we report the design of a device allowing on-chip optical wireless interconnections, based on transmitting and receiving Optical Phased Arrays (OPA). The proposed device aims at realizing high-bandwidth and power-efficient reconfigurable connections between multiple nodes, e.g. chiplets stacked onto a common silicon interposer in 2.5D manycore systems. The communication through an optical wireless switch is a completely novel approach to overcome the bottleneck of wired communication and to provide flexibility in the network topology configuration. We report the OPA design criteria as well as the results of three-dimensional Finite Difference Time Domain (FDTD) simulations. We exploit the in-plane radiation of simple taper antennas to implement  $1 \times N$  and  $N \times N$  switching matrices. The effect of the multipath propagation in the on-chip multi-layered medium is also taken into account.

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## 1. Introduction

Computing architectures at all scales are striving to keep up with the high-performance requirements of data-oriented analytics, while meeting constant power and thermal budgets [1]. As a result, new solutions for dense system-level integration are gaining momentum, such as 3D stacking or 2.5D integration. These solutions call for Tb/s-scale bandwidth densities and communication power efficiencies, that are out-of-reach for conventional electronics [2].

Chip-scale connectivity has been traditionally delivered through Networks-on-Chip (NoCs), where different cores are connected through electrical links and switching fabrics [3]. However, emerging data-intensive applications are bringing fundamental scalability bottlenecks to the forefront [4], especially its latency-inefficient multi-hop nature and a growing gap in the delivered communication bandwidth. The need of new solutions for interconnect technologies is clear and well-known [5].

A paradigm shift was achieved by the onset of Optical Networks-on-Chip (ONoC), enabled by the relentless penetration of photonic technology into smaller and smaller-scale systems traditionally dominated by electronics [6]. Especially in datacenters, ONoCs are being assessed for rack- and board-scale optical interconnection architectures, and claim massive any-to-any, buffer-less, collision-less and extremely low-latency switching platforms with bandwidth densities in the order of tens of Tb/s [7], which pave the way for their future deployment also at the chip scale to support 3D [8] or 2.5D integration [9].

The most common implementation for ONoCs is based on “wired” (i.e. waveguide-based) optical connections and routing matrices that exploit the resonant behavior of micro-ring resonators (MRR) [10–13]. The resonant nature of MRRs represents per se a possible bandwidth limitation

when Tb/s rates must be attained, unless cascades of a large number of rings are employed. As a fact, as the network size scales up and the number of transmitters and receivers increases, the power efficiency and communication reliability claims of ONoCs become progressively impaired [12]. The increase of insertion losses along optical paths, the proliferation of MRR devices, the need to fine-tune the resonant wavelengths through thermal tuning, and the number of wavelength-division multiplexed channels to support bandwidth density overall result in expensive static power budgets. The current trend in ONoCs is thus the definition of network topologies that minimize the overall number of resonant devices and that try to reduce the topological complexity [14].

Wireless on-chip networks (WiNoCs) have also been proposed as an alternative paradigm for the communication between different chips and, in most advanced proposals, between different cores [15–17]. The possibility of removing the overhead of network topology is indeed a great advantage of wireless communication. However, unless very high frequencies are chosen, such networks are limited by the size of the antennas and, consequently, by the chip area usage. Radio Frequency (RF) communication, which is the most mature wireless technology to date, results in bulky solutions which are impractical for NoC integration. The mm-wave or THz ranges indeed appear to be more suitable for on-chip integration, thanks to the smaller sizes of the antennas and to the achievable data rates of tens of Gb/s. For example, line-of-sight (LoS) links have been experimentally demonstrated at 142 GHz achieving data rates of 14 Gb/s over distances of 0.6 mm through silicon integrated antennas [18]. For on chip communication, graphene-based THz antennas are one of the most promising technologies, since the size of the radiators can be reduced up to a few tens of microns thanks to the occurrence of plasmonic resonance [19]. However, the on-chip integration of such antennas and of THz transceivers still requires intensive research and, to the best of our knowledge, is not yet mature.

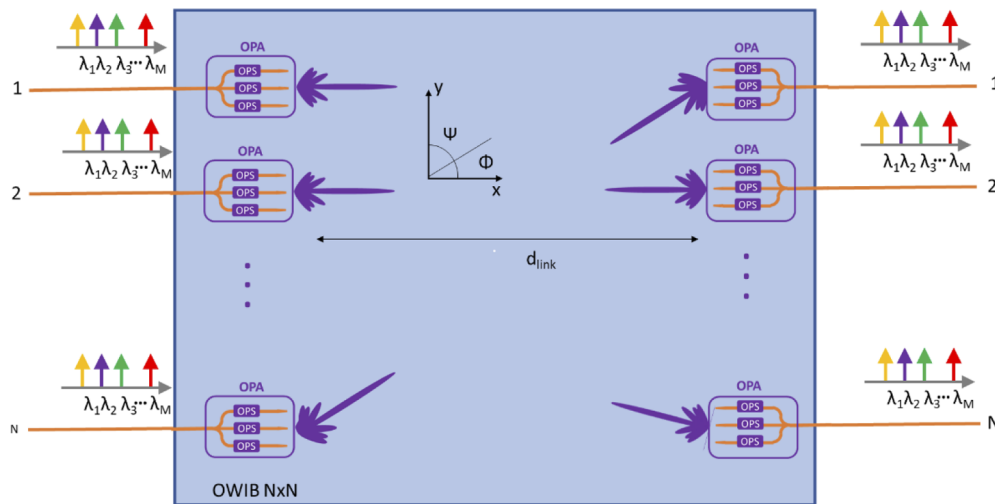
In this picture, optical wireless technology can provide attractive interconnect solutions, offering advantages in terms of data format and throughput transparency, and low sensitivity to inter-device electro-magnetic interference. Furthermore, the recent impressive advances in photonic integrated technologies allow for a reduction in footprint and power consumption, making photonics systems deployable at a chip-level scale. Among the photonic integration platforms, Silicon photonics [20] is particularly attractive. One reason is the high index contrast which, entailing a strong field confinement, allows for low propagation losses and waveguides with small bending radii. Moreover, thanks to its compatibility with CMOS processes [21], grants the possibility of exploiting CMOS fabrication facilities and integrating electronic and photonic devices on the same chip. Optical wireless interconnect technology has been recently proposed to exploit the best of both wireless and optical communications [22,23]. Different antennas have been investigated for on-chip wireless communication based on dielectric or plasmonic radiators [24–27]. Point-to-point links have been numerically and experimentally demonstrated [22,23] as well as beam steering through antenna arrays [22,25]. In particular, a  $1 \times N$  reconfigurable wireless switch, enabling beam steering of the transmitted signal by the phase shifting of an input antenna array, was reported in [22]. In this case, the transmitted signal is received by  $N$  single antennas (i.e. without reconfigurable beam-steering at the receivers), suitably positioned to minimize crosstalk.

In this paper, we propose the design and the numerical investigation of reconfigurable Optical Wireless Interconnections Blocks (OWIBs) exploiting the beam steering capabilities of Optical Phased Arrays (OPAs), i.e. optical antenna arrays with configurable phase shifts, both at the transmitter and at the receiver sections. The feasibility of this approach is supported by the integrated large-scale phased arrays, which have been already considered for off-plane beam steering in LIDAR applications [28]. Here, we exploit the in-plane radiation of simple taper antennas to implement  $1 \times N$  and  $N \times N$  switching matrices. We define the design criteria and we investigate the feasibility of  $1 \times N$  and  $N \times N$  OWIBs. Moreover, we analyze the OWIB

behavior taking into account the on-chip multilayer structure, which strongly influences the wave propagation.

## 2. Optical wireless interconnection block

A conceptual scheme of a  $N \times N$  OWIB is shown in Fig. 1, where  $N$  transmitters and  $N$  receivers are interconnected through reconfigurable antenna arrays lying on a dedicated optical layer. Figure 1 outlines a possible implementation of beam reconfigurability by OPAs made of integrated nanoantennas. In the scheme, the antennas are integrated with standard waveguides and they radiate a wavelength-division multiplexed (WDM) signal with parallel transmission of different data channels, i.e. the  $M$  different wavelengths  $\lambda$ . By shifting the phase of the input signals of the OPAs, through Optical Phase Shifters (OPSs), the radiated beam can be steered to communicate with a specific receiver. The phase shift necessary for the OWIB operation can be achieved in Si waveguides by using Optical Phase Shifters (OPS) based either on thermo-optic or plasma-optic effect [20].

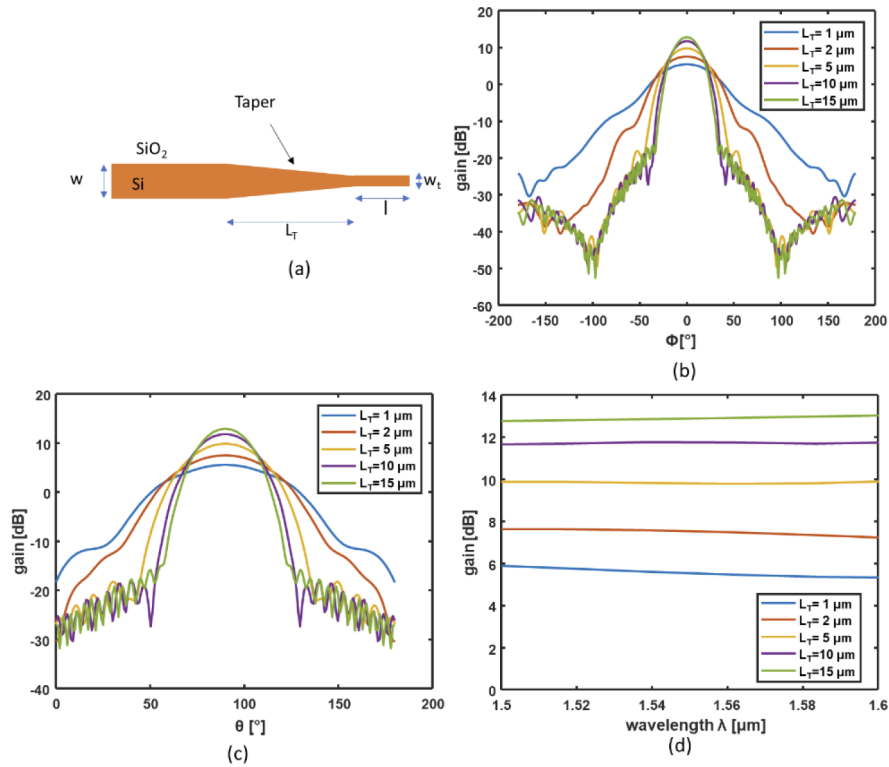


**Fig. 1.** Block diagram of an  $N \times N$  OWIB. OPA: Optical Phase Array; OPS: Optical Phase-Shifter

The transmitting and receiving OPAs schematized in Fig. 1 are made by aligning, along the  $y$ -axis, a number of radiators. If the optical signal at each antenna in the arrays is suitably phase-shifted, e.g. by thermo-optic or plasma-optic effect, the radiation beam can be steered in the propagation plane, i.e. the  $xy$ -plane. Since the focus of this work is the analysis of the feasibility of reconfigurable on-chip optical interconnections, we will consider only very simple radiators made of inversely tapered Silicon On Insulator (SOI) waveguides. Nonetheless, the design principles proposed are virtually applicable to any kind of antenna.

### 2.1. Taper antenna radiation characteristics

The taper antenna in Fig. 2(a) is obtained by inversely tapering a standard SOI waveguide, with cross-section height  $h=220\text{ nm}$  and width  $w=450\text{ nm}$ . The taper is terminated on a small tip with length  $l=1\text{ }\mu\text{m}$ , and width  $w_T=130\text{ nm}$ . The guided mode becomes evanescent while propagating in the inverse taper and, therefore, it is radiated in the surrounding dielectric. The gradual variation of the effective refractive index in the taper guarantees a good impedance matching with the surrounding medium and a low input back-reflection (i.e. less than  $-35\text{ dB}$ ). All those characteristics concur for an efficient conversion of the guided signal into wireless radiation.



**Fig. 2.** (a) Scheme of the taper antenna, (b) and (c) taper antenna gain, calculated by three-dimensional FDTD simulations, as a function of the angles  $\Phi$  (with  $\theta=90^\circ$  - horizontal plane) and  $\theta$  (with  $\Phi=0^\circ$  - vertical plane), respectively, for different values of the taper length  $L_T$ . (d) Maximum gain of the taper antenna as a function of the wavelength for different values of the taper length  $L_T$ .

In order to evaluate its radiation characteristics, the taper antenna was modelled through the three-dimensional Finite Difference Time Domain Method (FDTD) [29]. Standard near-to-far field projections of the fields recorded on a closed box, surrounding the antenna and the SOI waveguide, were calculated after the Fourier transformation of the time-domain electromagnetic field [29]. For the analysis of the radiation characteristics of the single antenna and for the design of the OPAs, the radiators were considered as embedded into a homogenous medium with refractive index  $n_{\text{SiO}_2}=1.445$  at the wavelength  $\lambda=1.55 \mu\text{m}$ , as required for an easier computation of the near-to-far-field transformation.

Figure 2(b) and (c) show the horizontal and vertical radiation diagrams, expressed in terms of the antenna gain, as a function of the angle  $\Phi$  (with  $\theta=\pi/2$  for the horizontal pattern) and as a function of  $\theta$  (with  $\Phi=0$  for the vertical pattern), respectively, for different values of the taper length  $L_T$ . The antenna gain  $G(\theta, \Phi)$  is defined as:

$$G(\theta, \Phi) = 4\pi \frac{I(\theta, \Phi)}{P_{in}} \quad (1)$$

where  $I(\theta, \Phi)$  is the radiation intensity and  $P_{in}$  is the input power launched into the strip waveguide. The angles  $\theta$  and  $\Phi$  are defined according to the spherical coordinate reference system (with  $\Phi$  in the xy plane shown in Fig. 1).

From Fig. 2(b) and (c), we can infer that an increase of the taper length  $L_T$  gives an increase of the antenna directivity and a narrowing of the radiated beam, even if for values of the taper length

above 10  $\mu\text{m}$  the improvement is not significant. For this antenna, the maximum radiation occurs in the  $xy$ -plane in the direction of the wave propagation (i.e.  $x$ -direction or  $\Phi=0$  and  $\theta=90^\circ$  in spherical coordinates).

Moreover, since the taper antenna is a non-resonant structure, its radiation characteristics are almost constant with the wavelength. For example, Fig. 2(d) shows the maximum gain of the taper antenna as a function of the wavelength for different values of the taper length  $L_T$ . For all the  $L_T$  values, the variation of the maximum gain in the wavelength range from  $\lambda = 1.50 \mu\text{m}$  to  $\lambda = 1.60 \mu\text{m}$  is less than 0.7 dB.

## 2.2. Design criteria for the OPAs and for $1 \times N$ interconnection element

According to antenna theory [30], the overall radiation diagram of an array made of an alignment of  $N_a$  identical antennas, can be calculated by multiplying the electromagnetic field radiated by the single antenna by the so-called array factor ( $AF$ ). The array factor  $AF$  is obtained by superimposing the contributions of point sources placed at the same position of each single antenna composing the array, and can be written as:

$$AF = \sum_{q=1}^{N_a} a_q e^{-j(q-1)[kd \cos(\Psi) + \alpha]} \quad (2)$$

where  $a_q$  is the excitation amplitude of each element,  $k = 2\pi n_m / \lambda$  is the propagation constant in a homogeneous medium with refractive index  $n_m$  at the wavelength  $\lambda$ ,  $d$  is the distance between the antennas, and  $\alpha$  is the phase shift of the input signal between two adjacent radiators. In Eq. (2),  $\Psi$  is the angle between the direction of the observation point and the axis of the linear array.

To simplify, in the following we will consider arrays with the same excitation amplitude for all the elements (uniform amplitude arrays). As a consequence, we can write  $a_q = 1$ . Moreover, as we are interested in interconnecting OPA on the  $xy$  plane (see Fig. 1), the  $AF$  will be expressed as a function of the angle  $\Phi = \pi/2 - \Psi$ , which indicates the direction of the observation point on this plane with respect to the perpendicular to the array axis. Equation (2) can therefore be rewritten in the form:

$$AF = \sum_{q=1}^{N_a} e^{-j(q-1)[kd \sin(\Phi) + \alpha]} \quad (3)$$

Once the overall electromagnetic field is calculated, the gain of the array can be obtained by applying Eq. (1).

In principle, different approaches for the OPA design based on the choice of the distance  $d$  between the antennas in the array are possible. From [30,31], given a fixed operating wavelength, the distance  $d$  between the antennas defines the extension of the so-called “visible region”. The “visible region” ranges from  $-kd$  to  $+kd$  and identifies the range of variability of the exponential term  $kd \sin(\Phi)$  in Eq. (3). The phase  $\alpha$  can be used to translate the visible range and suitably change the radiation pattern. In fact, through the choice of this parameter it is possible to tailor the radiation diagram of the array, i.e. to control the direction of the main lobe and of the nulls, the existence of grating lobes, etc.

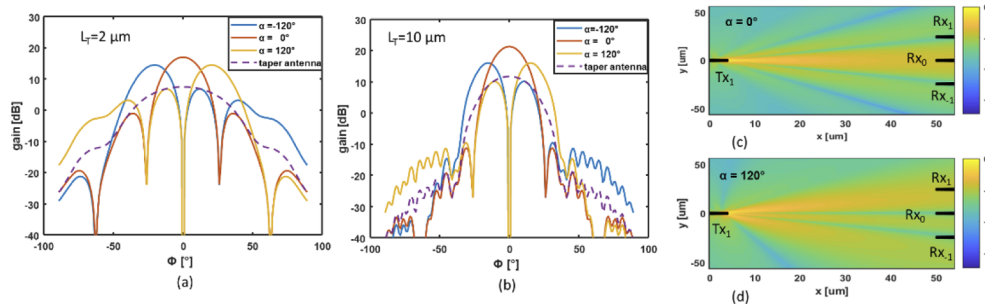
For example, considering a broadside uniform linear array (i.e. an array with phase-shift  $\alpha=0$ ,  $a_q = 1$  and constant distance  $d$  between adjacent antennas), when  $d < \frac{\lambda}{n_m}$  only one main lobe of the  $AF$  exists in the visible region. Conversely, when  $d \geq \frac{\lambda}{n_m}$ , multiple main radiation lobes (i.e. grating lobes) can fall in the “visible region”. As we will detail in the following, this occurrence can be exploited to increase the number of connected receivers. Steering of the main lobe in the  $xy$ -plane, and therefore realization of the  $1 \times N$  interconnection, is obtained by varying the phase shift  $\alpha$  among the excitations of the different elements.

We consider first the case of three taper antennas ( $N_a=3$ ) aligned along the  $y$  direction with distance  $d = \frac{3\lambda}{4n_{SiO_2}}$  which allows, for a broadside array, to obtain a single main lobe in the radiation pattern. In this case, the first nulls around the main lobe are along the directions corresponding

to:

$$\Phi_{null} = \pm \sin^{-1} \left[ \frac{\lambda}{2\pi d n_m} \left( \frac{2\pi}{N_a} \right) \right]. \quad (4)$$

Figure 3(a) shows the gain of the array as a function of the angle  $\Phi$  for an array of  $N_a=3$  taper antennas with  $L_T=2 \mu\text{m}$ . In particular, Fig. 5(a) illustrates the gain for three different values of the phase shift, i.e.  $\alpha=0$  (red curve) and  $\alpha=\pm 120^\circ$  (yellow and blue curve, respectively), which are the phase shifts required to steer the maximum of the radiation diagram (i.e.  $\alpha=\pm 360^\circ/N_a$ ) on the same positions of the nulls of the broadside ( $\alpha=0^\circ$ ) array. The radiation diagram of the single taper antenna is also reported (violet curve) for comparison.



**Fig. 3.** Gain as a function of the angle  $\Phi$  for an array of  $N_a=3$  taper antennas with antenna distance  $d = \frac{3\lambda}{4n_{SiO_2}}$ , and taper length (a)  $L_T=2 \mu\text{m}$ , and (b)  $L_T=10 \mu\text{m}$ , for three different values of the phase shift  $\alpha=0$  (red curve), and  $\alpha=\pm 120^\circ$  (yellow and blue curve, respectively). The gain of the single taper antenna is also reported (violet dashed curve). Electric field pattern in the  $xy$ -plane calculated by 3D-FDTD simulations for (c)  $\alpha=0$ , and (d)  $\alpha=120^\circ$ , with  $L_T=2 \mu\text{m}$ ,  $d_{\text{link}}=45 \mu\text{m}$  and  $\lambda = 1550 \text{nm}$ . The color bar represents the normalized amplitude of the electric field in logarithmic scale.

As this figure shows, by changing the phase  $\alpha=\pm 120^\circ$  the main radiation lobe is steered of an angle  $\Phi_{null}=\pm 26^\circ$ , which corresponds to a null of the radiation diagram when  $\alpha=0^\circ$  (broadside array). The radiation diagram of the single taper antenna, with its own beamwidth and its maximum for  $\Phi=0$ , is responsible of the attenuation of the maximum gain of the steered beams with respect to the value of the broadside array (of about 2.5 dB). For this reason, using extremely narrow-beam radiators is not the best solution for this application.

For the sake of comparison, Fig. 3(b) shows the overall gain as a function of the angle  $\Phi$  for an array of  $N_a=3$  taper antennas with  $L_T=10 \mu\text{m}$ , for the same phase shift  $\alpha$  values of Fig. 3(a). In the same figure, the gain calculated for the single taper antenna with  $L_T=10 \mu\text{m}$  is also reported (violet dashed curve). The behavior is similar to the one shown in Fig. 3(a), and the nulls of the radiation diagram for  $\alpha=0$  (red curve) occur always at  $\Phi_{null}=\pm 26^\circ$ . As expected, by comparing Figs. 3(a) and (b), we can observe that higher gain is achieved (increase of about 4 dB) for more directive single antennas. As a counterpart, the reduction of the maximum gain of the steered beam tends to rise ( $\cong 5 \text{dB}$ ), as expected for the increased gain and reduced beamwidth of the single element for  $\Phi=0^\circ$ .

It is worth mentioning that the curves reported in Fig. 3 were verified by 3D-FDTD simulation of the whole array immersed in a homogeneous medium, achieving an almost perfect agreement of the results. This confirms that, for a first design of the OWIB, it is possible to simply rely on the analytic formulation instead of simulating the complete structure.

Considering the radiation diagrams shown in Figs. 3(a) or (b), three different receivers can therefore be addressed by changing the phase of the input signal (i.e.  $\alpha=0$ , and  $\alpha=\pm 120^\circ$ ), thus obtaining a  $1 \times 3$  wireless switch. It is worth pointing out that the crosstalk between the different receivers can be minimized by placing them at  $\Phi=0$  and  $\Phi=\pm \Phi_{null}$  of the transmitting antenna.

As an example, Figs. 3(c) and (d) show the electric field pattern in the  $xy$ -plane calculated by 3D-FDTD simulation for (c)  $\alpha=0^\circ$ , and (d)  $\alpha=120^\circ$ , with a distance between the transmitter ( $Tx_1$ ) and the receivers ( $Rx_0$ , and  $Rx_{\pm 1}$ ) equal to  $d_{link}=45 \mu m$ . The considered wavelength is  $\lambda = 1550 nm$ . The color bar represents the normalized amplitude of the electric field in logarithmic scale. The geometrical position of the receiving OPAs (i.e.  $Rx_{\pm 1}$ ) was determined by the equation  $y_{\pm 1} = \pm d_{link} \tan(\Phi_{null})$ .

Figure 3(c) qualitatively shows that, when  $\alpha=0^\circ$ ,  $Rx_0$  is illuminated by the main lobe, whereas both  $Rx_{\pm 1}$  fall in radiation minima. Similarly, as shown in Fig. 3(d), when  $\alpha=120^\circ$  the receiver  $Rx_{+1}$  is illuminated by the steered main lobe, whereas the other two receivers fall in radiation minima.

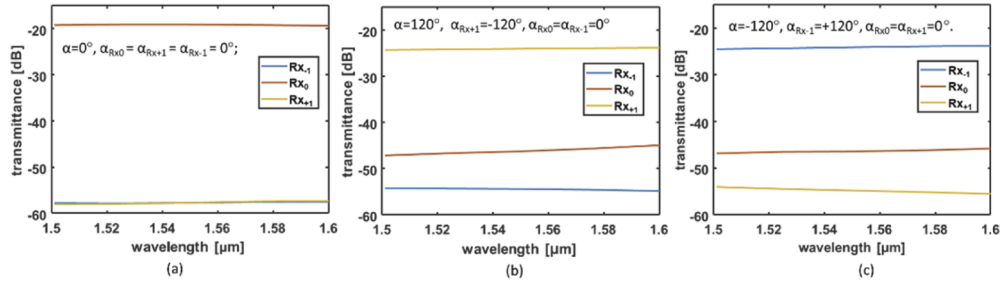
This configuration can therefore be used to realize a  $1 \times 3$  interconnection between a transmitter and three receivers suitably positioned as previously discussed. It is now important to analyze quantitatively the performance of this device in terms of power transfer and crosstalk.

It is worth pointing out that, in order to guarantee the  $1 \times 3$  interconnection, it is also necessary to virtually steer the beam of the receiving OPAs in the direction of the maximum radiation. This is feasible by properly phase-shifting the mode amplitudes of the fundamental TE mode in each waveguide at the receiving OPAs. The mode amplitude, obtained through a mode expansion monitor [29], represents the fraction of the received signal coupled into each waveguide by the corresponding antenna.

Figure 4 shows the transmittance in dB at the receiving OPAs, i.e.  $Rx_0$ , and  $Rx_{\pm 1}$ , calculated by 3D-FDTD simulations. Each OPA, either transmitting or receiving, is made of three taper antennas with taper length  $L_T=2 \mu m$ , and antenna distance  $d = \frac{3\lambda}{4n_{SiO_2}}$ . The phase shifts of the OPAs are chosen to guarantee a  $1 \times 3$  interconnection between the transmitter and the receivers. Specifically, to connect the transmitter with the in-line receiver ( $Tx \rightarrow Rx_0$ ), with the receiver at  $\Phi=26^\circ$  ( $Tx \rightarrow Rx_1$ ), and with the receiver at  $\Phi=-26^\circ$  ( $Tx \rightarrow Rx_{-1}$ ), the phase shifts at the transmitting and at the receiving OPAs are, respectively: (a)  $\alpha=0^\circ$ ,  $\alpha_{Rx0} = \alpha_{Rx+1} = \alpha_{Rx-1} = 0^\circ$ ; (b)  $\alpha=120^\circ$ ,  $\alpha_{Rx+1} = -120^\circ$ , and  $\alpha_{Rx0} = \alpha_{Rx-1} = 0^\circ$ ; (c)  $\alpha=-120^\circ$ ,  $\alpha_{Rx-1} = +120^\circ$ , and  $\alpha_{Rx0} = \alpha_{Rx+1} = 0^\circ$ . The simulations were performed considering the propagation in a homogeneous medium with refractive index  $n_{SiO_2}=1.445$  and a link distance between TX and  $Rx_0$   $d_{link} = 45 \mu m$ . In each plot of Fig. 4, the transmittance of every link, computed as the total power coupled into the receiver waveguides divided by that at the transmitter, is reported. Transmittances are in dB scale and refer to different values of the phase shifts  $\alpha$  at the transmitter and at the receivers. Figure 4(a) is for the case in which all the arrays are in the broadside configuration. As expected, the central receiver is the one which is better illuminated by the transmitting antenna. The transmittance of  $Rx_0$  is, in fact, maximized. The difference between the transmittance at  $Rx_0$  and at  $Rx_{+1}$ , or  $Rx_{-1}$ , represents the crosstalk, being these two receivers not interested in communicating with the transmitter in the considered layout.

Figure 4(b) and (c) illustrate the different scenarios in which the transmitter aims at communicating with  $Rx_{+1}$  and  $Rx_{-1}$ , respectively. In these two configurations, the link power budget between the Tx and the receiver involved in the communication is reduced with respect to the first scenario and the crosstalk is, on the contrary, increased. The reduced performance can be explained by considering the radiation diagrams of the arrays reported in Fig. 3(a) and the reciprocal path lengths between each transmitting and receiving OPAs. When communication takes place in tilted directions, in fact, the performance of the arrays is reduced, lateral lobes create more interference, and the link distance grows.

Considering Fig. 4, the worst-case crosstalk occurs between  $Rx_0$  and either  $Rx_{+1}$  or  $Rx_{-1}$ , and it is equal to  $-22$  dB. The insertion losses (i.e. about 20 dB for  $\alpha=0^\circ$ , and 24 dB for  $\alpha=120^\circ$ ), which are due to the propagation in a homogeneous medium, agree with the well-known Friis transmission equation [31].



**Fig. 4.** Transmittance in dB, calculated by 3D-FDTD simulations, at the receiving OPAs, i.e.  $Rx_0$  ( $\Phi=0^\circ$ ), and  $Rx_{\pm 1}$  ( $\Phi=\pm 26^\circ$ ), with three taper antennas for each array, and taper length  $L_T=2 \mu\text{m}$ , antenna distance  $d = \frac{3\lambda}{4n_{\text{SiO}_2}}$ , and link distance  $d_{\text{link}} = 45 \mu\text{m}$ . The phase shift at the transmitting and at the receiving OPAs are, respectively: (a)  $\alpha=0^\circ$ ,  $\alpha_{Rx0} = \alpha_{Rx+1} = \alpha_{Rx-1} = 0^\circ$ ; (b)  $\alpha=120^\circ$ ,  $\alpha_{Rx+1} = -120^\circ$ , and  $\alpha_{Rx0} = \alpha_{Rx-1} = 0^\circ$ ; (c)  $\alpha=-120^\circ$ ,  $\alpha_{Rx-1} = +120^\circ$ , and  $\alpha_{Rx0} = \alpha_{Rx+1} = 0^\circ$ . The simulations were performed considering the propagation in a homogeneous medium with refractive index  $n_{\text{SiO}_2}=1.445$ .

The choice of using three elements in the OPA was made in the hypothesis of simplifying the fabrication of the OWIBs and of reducing the complexity of the circuitry driving the thermal phase-shifters in a fabricated sample. Nonetheless, it is possible to realize arrays with more than three elements which are expected, from antenna theory, to have higher gain.

As an example, Fig. 5(a) shows the gain as a function of the angle  $\Phi$  for an array of  $N_a=5$  taper antennas with antenna distance  $d = \frac{3\lambda}{4n_{\text{SiO}_2}}$ , and taper length  $L_T=2 \mu\text{m}$ . In particular, Fig. 3(a) illustrates the gain for three different values of the phase shift, i.e.  $\alpha=0$  (red curve) and  $\alpha=\pm 72^\circ$  (yellow and blue curve, respectively). Also in this case, the phase shifts  $\alpha=\pm 360^\circ/N_a$  steer the maximum of the radiation diagram on the same positions of the nulls of the broadside ( $\alpha=0^\circ$ ) array. The radiation diagram of the single taper antenna is also reported (violet curve) for comparison.

Figure 5(b), (c), and (d) show the transmittance in dB at the receiving OPAs, i.e.  $Rx_0$ , and  $Rx_{\pm 1}$ , calculated by 3D-FDTD simulations in the case of OPAs with  $N_a=5$  taper antennas, taper length  $L_T=2 \mu\text{m}$ , and antenna distance  $d = \frac{3\lambda}{4n_{\text{SiO}_2}}$ . The phase shifts at the transmitting and at the receiving OPAs are, respectively: (b)  $\alpha=0^\circ$ ,  $\alpha_{Rx0} = \alpha_{Rx+1} = \alpha_{Rx-1} = 0^\circ$ ; (c)  $\alpha=72^\circ$ ,  $\alpha_{Rx+1} = -72^\circ$ , and  $\alpha_{Rx0} = \alpha_{Rx-1} = 0^\circ$ ; (d)  $\alpha=-72^\circ$ ,  $\alpha_{Rx-1} = +72^\circ$ , and  $\alpha_{Rx0} = \alpha_{Rx+1} = 0^\circ$ . The simulations were performed considering the propagation in a homogeneous medium with refractive index  $n_{\text{SiO}_2}=1.445$  and a link distance between TX and  $Rx_0$   $d_{\text{link}} = 45 \mu\text{m}$ .

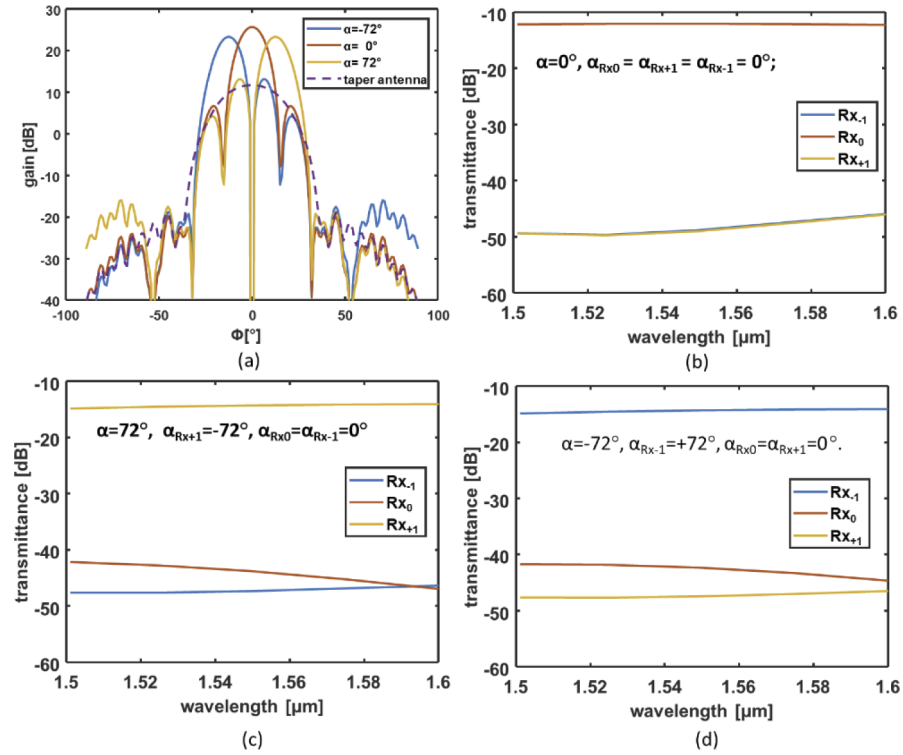
Considering Figs. 5(b), (c), and (d), the worst-case crosstalk occurs between  $Rx_0$  and either  $Rx_{+1}$  or  $Rx_{-1}$ , and it is equal to  $-27$  dB. The insertion losses are about 12 dB for  $\alpha=0^\circ$ , and 14 dB for  $\alpha=72^\circ$ .

Compared to the case of  $N_a=3$  shown in Figs. 4, the insertion loss is improved of 8 dB for  $\alpha=0^\circ$ , and of about 10 dB for  $\alpha=72^\circ$ . An improvement of 5 dB of the crosstalk is also achieved. As a counterpart, since more antennas are considered, more power is expected to be required to drive the phase shifters of each OPA. In fact, if  $P_\alpha$  is the power required for achieving a phase shift equal to  $\alpha$ , the total power required for steering an OPA with  $N_a$  antennas can be roughly estimated as  $P_{\text{OPA}}=(N_a-1) P_\alpha$ .

As expected from antenna theory, increasing the distance  $d$  among the radiators, leads to having multiple main lobes of the AF in the visible space. For a broadside array, this is observed when  $d \geq \frac{\lambda}{n_m}$ . However, as shown below, this feature can be exploited to address more receivers.

As an example, here we consider the case of OPAs made of three taper antennas ( $N_a=3$ , with taper length  $L_T=2 \mu\text{m}$ ) aligned along the y direction as before, but with distance  $d = 2 \frac{\lambda}{n_{\text{SiO}_2}}$ . Figure 6(a) shows the corresponding overall gain of the array as a function of the angle  $\Phi$ . Also in





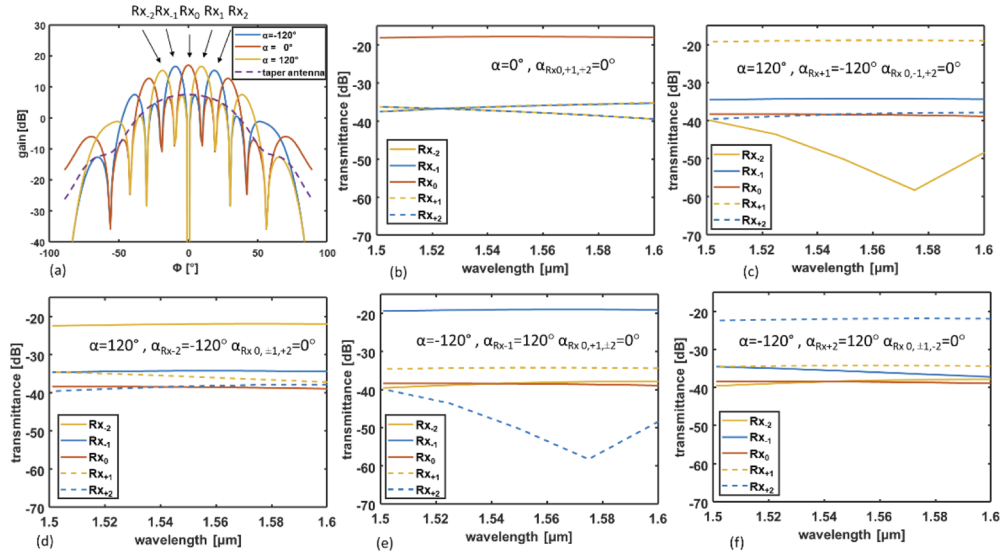
**Fig. 5.** (a) Gain as a function of the angle  $\Phi$  for an array of  $N_a=5$  taper antennas with antenna distance  $d = \frac{3\lambda}{4n_{SiO_2}}$ , and taper length  $L_T=2 \mu\text{m}$ . (b), (c) and (d) Transmittance in dB, calculated by 3D-FDTD simulations, at the receiving OPAs, i.e.  $Rx_0$  ( $\Phi=0^\circ$ ), and  $Rx_{\pm 1}$  ( $\Phi=\pm 15^\circ$ ), with five taper antennas for each array, and taper length  $L_T=2 \mu\text{m}$ , antenna distance  $d = \frac{3\lambda}{4n_{SiO_2}}$ , and link distance  $d_{link} = 45 \mu\text{m}$ . The phase shift at the transmitting and at the receiving OPAs are, respectively: (b)  $\alpha=0^\circ, \alpha_{Rx0} = \alpha_{Rx+1} = \alpha_{Rx-1} = 0^\circ$ ; (c)  $\alpha=72^\circ, \alpha_{Rx+1} = -72^\circ$ , and  $\alpha_{Rx0} = \alpha_{Rx-1} = 0^\circ$ ; (d)  $\alpha=-72^\circ, \alpha_{Rx-1} = +72^\circ$ , and  $\alpha_{Rx0} = \alpha_{Rx+1} = 0^\circ$ . The simulations were performed considering the propagation in a homogeneous medium with refractive index  $n_{SiO_2}=1.445$ .

this case, the OPA gain was calculated from Eq. (1) applied to the 3D-FDTD simulated far-field of the taper antenna multiplied by the  $AF$  of Eq. (3).

As one can observe, by applying the phase shifts  $\alpha = \pm 120^\circ$  (yellow and blue curve, respectively) to the array elements of the transmitter, it is possible to steer the maxima of the radiation diagrams to the new positions of the radiation nulls of the broadside array ( $\alpha=0$ , red curve), which are now at  $\Phi_{null} = \pm 10^\circ$ , in agreement with Eq. (4) when  $d$  is incremented.

With this approach it is possible to obtain a  $1 \times 5$  wireless switch. In fact, by considering the radiation diagrams shown in Figs. 6(a) one can note that five different receivers can be addressed with the main radiation lobes by the transmitter through suitable phase modification of the input signals (i.e.  $\alpha=0$ , and  $\alpha = \pm 120^\circ$ ). The five receivers  $Rx_i$  (with  $i=0, \pm 1, \pm 2$ ) should be placed in correspondence of the radiation peaks/nulls as indicated in Fig. 6(a), according to the strategy previously adopted. Then, each receiver will select the incoming signal by using the same phase-tuning approach described for the transmitter. Also in this case, the geometrical position of the receiving OPAs (i.e.  $Rx_i$ ) can be determined by the equation:

$$y_i = d_{link} \tan(\Phi_{null_i}),$$



**Fig. 6.** (a) Gain as a function of the angle  $\Phi$  for an array of  $N_a=3$  taper antennas with antenna distance  $d = 2 \frac{\lambda}{n_{\text{SiO}_2}}$ , and taper length  $L_T=2 \mu\text{m}$  for three different values of the phase shift  $\alpha=0$  (red curve), and  $\alpha=\pm 120^\circ$  (yellow and blue curve, respectively). The gain of the single taper antenna is also reported (violet dashed curve). (b-f) Transmittance in dB, calculated by 3D-FDTD simulations, at the receiving OPAs, i.e.  $\text{Rx}_0$ , and  $\text{Rx}_{\pm 1}$ , and  $\text{Rx}_{\pm 2}$  with link distance  $d_{\text{link}} = 45 \mu\text{m}$ . The phase shift at the transmitting and at the receiving OPAs are, respectively: (b)  $\alpha=0^\circ, \alpha_{\text{Rx}0, \pm 1, \pm 2}=0^\circ$ ; (c)  $\alpha=120^\circ, \alpha_{\text{Rx}+1}=-120^\circ, \alpha_{\text{Rx}0, -1, \pm 2}=0^\circ$ ; (d)  $\alpha=120^\circ, \alpha_{\text{Rx}-2}=-120^\circ, \alpha_{\text{Rx}0, \pm 1, \pm 2}=0^\circ$ ; (e)  $\alpha=-120^\circ, \alpha_{\text{Rx}-1}=120^\circ, \alpha_{\text{Rx}0, +1, \pm 2}=0^\circ$ ; (f)  $\alpha=-120^\circ, \alpha_{\text{Rx}+2}=120^\circ, \alpha_{\text{Rx}0, +1, \pm 2}=0^\circ$ . The simulations were performed considering the propagation in a homogeneous medium with refractive index  $n_{\text{SiO}_2}=1.445$ .

with  $i=\pm 1, \pm 2$ .

Figure 6(b)-(f) show the corresponding transmittances, calculated by 3D-FDTD simulation, at the receiving OPAs i.e.  $\text{Rx}_0$ , and  $\text{Rx}_{\pm 1}$ , and  $\text{Rx}_{\pm 2}$  with link distance  $d_{\text{link}} = 45 \mu\text{m}$ . The input and output phase-shifts, necessary for the  $1 \times 5$  interconnection, are reported. Also in this case, the simulations were performed considering the propagation in a homogeneous medium with refractive index  $n_{\text{SiO}_2}=1.445$ .

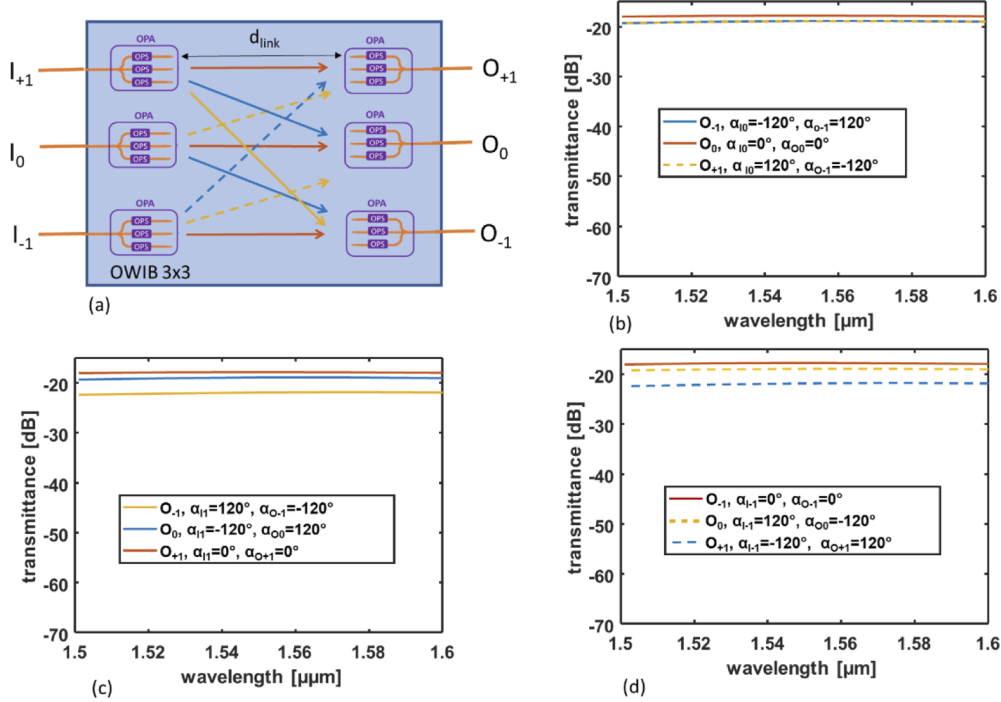
The worst-case insertion loss, i.e. 21.87 dB, occurs when the more external receivers  $\text{Rx}_{\pm 2}$  are used, whereas the best performance in terms of insertion loss, i.e. 17.77 dB, pertains to  $\text{Rx}_0$ . This occurrence agrees with the radiation diagram in Fig. 6(a) where the gain peaks decrease for higher values of  $|\Phi|$ . The worst-case crosstalk, i.e.  $-12.5$  dB, occurs either between  $\text{Rx}_{+1}$  and  $\text{Rx}_{+2}$ , or between  $\text{Rx}_{-1}$  and  $\text{Rx}_{-2}$ .

Comparing the results of the reported designs of OPAs, we can state that antenna distance values  $d \geq \frac{\lambda}{n_m}$  allow to increase the number of reachable receivers and give better performances in terms of insertion loss. As a further advantage, larger values of the distance  $d$  between adjacent antennas allow to prevent undesired coupling between the input waveguides. As a counterpart, the crosstalk is increased.

### 2.3. $3 \times 3$ optical wireless interconnection blocks

Starting from the OPA design with a distance  $d = 2 \frac{\lambda}{n_{\text{SiO}_2}}$  among the array elements, a  $3 \times 3$  matrix connecting three transmitters ( $\text{I}_0$ , and  $\text{I}_{\pm 1}$ ) and three receivers ( $\text{O}_0$ , and  $\text{O}_{\pm 1}$ ) according to the scheme shown in Fig. 7(a) can be implemented. Since the OPAs in the  $3 \times 3$  matrix are

characterized by the radiation diagrams shown in Fig. 6(a), the communication between the further nodes (i.e. between  $I_{-1}$  and  $O_{+1}$ , and between  $I_{+1}$  and  $O_{-1}$ ) is allowed by the radiation lobes denoted by  $Rx_{\pm 2}$  in Fig. 6(a). The arrows in Fig. 7(a) denote the possible interconnections between the nodes and the arrow colors and line-styles follow that of the curves in Figs. 7(b)-(d).



**Fig. 7.** (a) Scheme of the  $3 \times 3$  Optical Wireless Interconnection Block, (b-d) Transmittance in dB, calculated by 3D-FDTD simulation, at the connected receiving OPAs i.e.  $O_0$ , and  $O_{\pm 1}$ , with three taper antennas for each array, and taper length  $L_T=2 \mu\text{m}$ , antenna distance  $d = \frac{2\lambda}{n_{\text{SiO}_2}}$ , and link distance  $d_{\text{link}} = 45 \mu\text{m}$ . The input signal is launched at (b)  $I_0$ , (c)  $I_{+1}$ , and (d)  $I_{-1}$ . The simulations are performed considering the propagation in a homogeneous medium with refractive index  $n_{\text{SiO}_2}=1.445$ .

Figure 7(b)-(d) shows the transmittance, calculated by 3D-FDTD simulation, at the receiving OPAs, i.e.  $O_0$ , and  $O_{\pm 1}$ , with link distance  $d_{\text{link}} = 45 \mu\text{m}$ . All the OPAs are made of three taper antennas, with taper length  $L_T=2 \mu\text{m}$ . In particular, the calculated transmittance in Figs. 7(b)-(d) pertain to the three connected receivers (i.e.  $O_0$ , and  $O_{\pm 1}$ ), when the input signal is launched at (b)  $I_0$ , (c)  $I_1$ , and (d)  $I_{-1}$ , respectively. The input and output phase-shifts, necessary for the  $3 \times 3$  interconnection block, are also reported in Figs. 7(b)-(d) and summarized in Table 1. For each input/output connection, the phase-shifts are considered equal to zero when not indicated.

**Table 1.** Interconnection matrix reporting the phase shifts of the transmitting and receiving OPAs needed to link the input and output ports of a  $3 \times 3$  OWIB. For each input/output connection, the phase-shifts are equal to zero when not indicated.

INPUT	OUTPUT		
	$O_{-1}$	$O_0$	$O_{+1}$
$I_{-1}$	$\alpha_{I_{-1}}=0^\circ, \alpha_{O_{-1}}=0^\circ$	$\alpha_{I_{-1}}=120^\circ, \alpha_{O_0}=-120^\circ$	$\alpha_{I_{-1}}=-120^\circ, \alpha_{O_{+1}}=120^\circ$
$I_0$	$\alpha_{I_0}=-120^\circ, \alpha_{O_{-1}}=120^\circ$	$\alpha_{I_0}=0^\circ, \alpha_{O_0}=0^\circ$	$\alpha_{I_0}=120^\circ, \alpha_{O_{-1}}=-120^\circ$
$I_{+1}$	$\alpha_{I_{+1}}=120^\circ, \alpha_{O_{-1}}=-120^\circ$	$\alpha_{I_{+1}}=-120^\circ, \alpha_{O_0}=120^\circ$	$\alpha_{I_{+1}}=0^\circ, \alpha_{O_{+1}}=0^\circ$

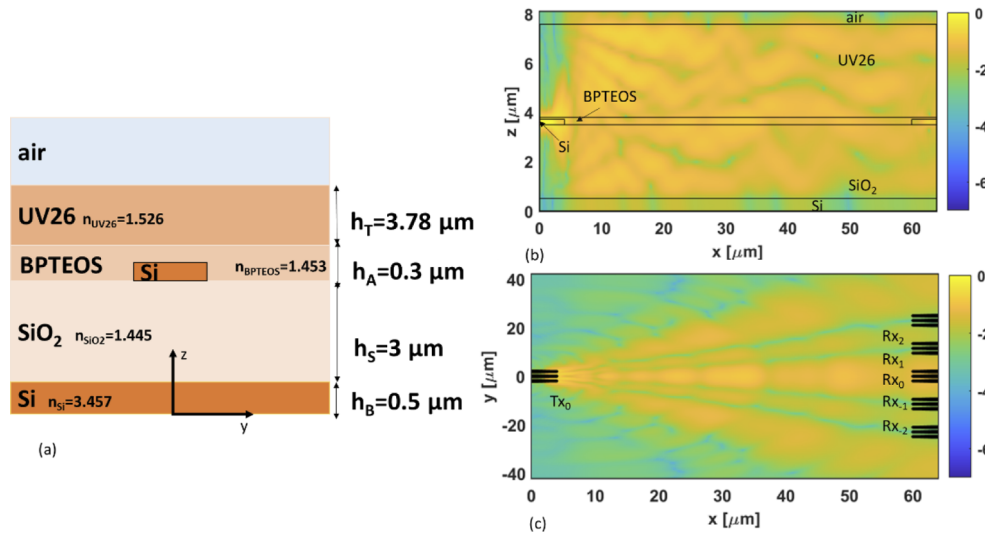
The behavior of the  $3 \times 3$  matrix indeed follows that of the  $1 \times 5$  interconnection previously described. Therefore, also in this case, the maximum calculated crosstalk is equal to  $-12.5$  dB.

### 3. Effect of multipath propagation

All the results discussed above refer to 3D-FDTD simulations of the antenna arrays immersed in a homogeneous  $\text{SiO}_2$  medium. This analysis is helpful to define the design criteria, but it neglects multipath propagation phenomena generated by the medium discontinuities existing in SOI-based on-chip optical wireless scenario. As numerically and experimentally investigated by the authors in [23], the propagation in an on-chip multilayered structure causes multiple reflections of the optical signal at the interfaces. This phenomenon can induce either an increase of the received power, thanks to constructive interference, or a fading of the signal due to destructive interference. In [23] optical wireless point-to-point links are analyzed either numerically or experimentally. The wireless links exploit the same taper antennas used in this work as transmitters and receivers. The simulation results in [23] are obtained by 3D FDTD considering the propagation in the on-chip multilayer structure, which corresponds to the fabricated sample. In [23] the numerical results are compared with the experimental ones showing a good agreement and confirming, at the same time, the presence of multi path propagation and the capability of predicting on-chip propagation by numerical simulations.

In order to verify the feasibility of the  $1 \times 5$  and of the  $3 \times 3$  switches in a more realistic on-chip propagation model, taking into account the multipath phenomenon, we simulated the OWIBs considering the multilayer structure in Fig. 8(a), which corresponds to the sample fabricated and already characterized in [23] for the evaluation of point-to-point wireless links. In particular, it consists of a standard SOI sample with a bottom layer of Si of thickness  $h_B = 675 \mu\text{m}$ , an overlying layer of  $\text{SiO}_2$  of  $h_S = 3 \mu\text{m}$  height, and a further layer of Silicon of  $h = 220 \text{nm}$  thickness, housing the standard Si waveguides and the taper antennas. The antenna layer is covered with a thin layer ( $h_A = 300 \text{nm}$ ) of borophosphorous tetraethyl orthosilicate (BPTEOS), which has a refractive index very close to the one of  $\text{SiO}_2$  ( $n_{\text{BPTEOS}}=1.453$ ). A polymer-based top layer made of UV26 of thickness  $h_T = 3.78 \mu\text{m}$  and refractive index  $n_{\text{UV26}} = 1.526$  is also considered above the BPTEOS. The  $\text{SiO}_2$ , BPTEOS, and UV26 define an overall quasi-homogenous medium, thanks to the small difference of the refractive index. The topmost layer is air, which is considered as infinite in the simulations by using Perfectly Matched Layer (PML) boundary conditions. The PML conditions were also applied to the bottom Si layer to approximate its finite thickness ( $h_B = 675 \mu\text{m}$ ) as infinite, and on all the lateral boundaries of the computational domain.

To better describe the effect of multipath propagation, Figs. 8(b) and (c) show the electric field pattern calculated by 3D-FDTD simulation (b) in the  $xz$ -plane for  $y=0 \mu\text{m}$ , and (c) in the  $xy$ -plane for  $z=3.61 \mu\text{m}$ , i.e. in the middle of the waveguide cross-section. The solid lines denote the geometry of the antennas and the different layers. The color bar represents the normalized amplitude of the electric field in logarithmic scale. In Fig. 8(b) and (c) a  $1 \times 5$  OWIB is considered, which exploits transmitting and receiving OPAs made of three taper antennas with taper length  $L_T=2 \mu\text{m}$  and phase-shift  $\alpha=0^\circ$ . As we can see in Fig. 8(b), a sort of field-confinement effect occurs, in the vertical  $xz$ -plane, between the bottom Si- and top air-layers, where multiple reflections and transmissions occur at the interfaces. Conversely, the interfaces between  $\text{SiO}_2$ , BPTEOS, and UV26 induce negligible perturbation of the propagating electromagnetic signal. In the  $xy$ -plane (Fig. 8(c)) the field distribution basically corresponds to the radiation pattern shown in Fig. 3(a) for phase shift  $\alpha=0^\circ$ , with some spatial fluctuations induced by the multipath interference. The multipath effect does not seem to influence strongly the propagation, and this can relax the need for careful design of the distance between the input and the output OPAs. Nevertheless, the sensitivity of the OWIB performance to multipath interference might increase at larger distance, where reflections become more grazing and multipath propagation lengths more similar, thus supporting the reception of signal contributions with similar intensity and therefore

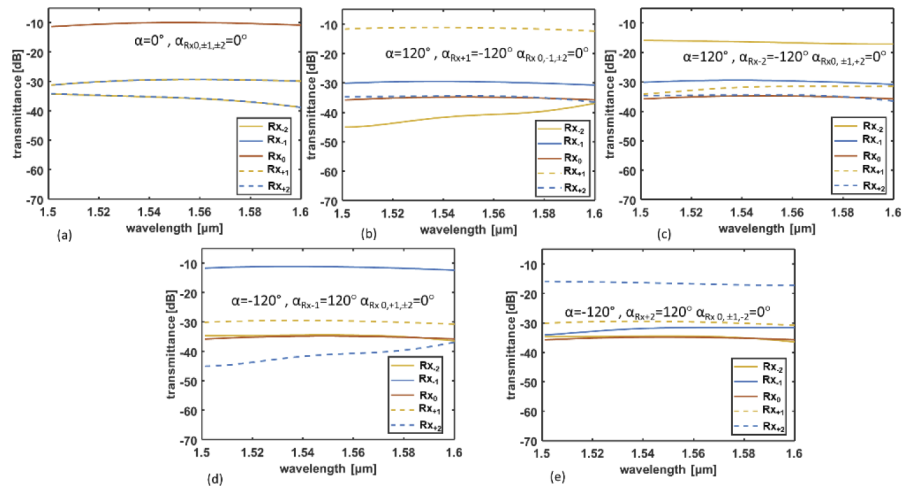


**Fig. 8.** (a) Scheme of the on-chip multilayered structure of the  $yz$ -cross section. A single Si waveguide is shown. (b-c) Electric field pattern calculated by 3D-FDTD simulation (b) in the  $xz$ -plane for  $y=0 \mu\text{m}$ , and (c) in the  $xy$ -plane for  $z=3.61 \mu\text{m}$ , i.e. in the middle of the waveguide cross-section, for a  $1 \times 5$  OWIB with OPAs made of three taper antennas with taper length  $L_T=2 \mu\text{m}$  and phase-shift  $\alpha=0^\circ$ . The solid lines denote the geometry of the antennas and the different layers. The color bar represents the normalized amplitude of the electric field in logarithmic scale.

triggering stronger interference effects. Finally, it is also worth noting that any change in the antenna layout and/or in the layers thickness and refractive properties may affect the interference pattern – even at the shorter range – to an extent that should be investigated case by case.

As analyzed in [23], for relatively short propagation distances (i.e. up to  $250 \mu\text{m}$ ), the propagation in the multilayered medium can be beneficial in terms of an increase of the received power with respect to free-space propagation. However, the multipath interference phenomenon must be accounted in the OWIB design for avoiding destructive interference when choosing the position of the receivers. For this purpose, we slightly modified the initial design of the  $1 \times 5$  matrix by considering an antenna distance equal to  $d=2\lambda/n_{UV26}$ , and by optimizing the receiving OPA position by parametric simulations.

Figure 9 shows the transmittance in dB at the receiving OPAs, i.e.  $Rx_0$ ,  $Rx_{\pm 1}$ , and  $Rx_{\pm 2}$ , calculated by 3D-FDTD simulations for  $1 \times 5$  OWIB with multilayered propagation medium. Each OPA is made of three taper antennas with taper length  $L_T=2 \mu\text{m}$ , and antenna distance  $d = 2\frac{\lambda}{n_{UV26}}$ . The phase-shifts ( $\alpha$ , and  $\alpha_{Rx}$ ) of the OPAs are chosen to guarantee the  $1 \times 5$  interconnection between the transmitter and the receivers, as indicated in Fig. 9. The reported results are obtained considering optimized values of the link distance  $d_{\text{link}}=55 \mu\text{m}$  and of the position of the receiving OPAs, i.e.  $y_{\pm 1}=11.5 \mu\text{m}$ , and  $y_{\pm 2}=23 \mu\text{m}$ , to compensate the oscillations of the received power due to the multipath effect and the perturbation of the radiation diagram induced by the multilayered medium. The behavior of the  $1 \times 5$  OWIB in the multilayered medium is very similar to the one in homogeneous medium, but an increase of the maximum received power of about 8 dB is observed, due to the guiding effect of the layered structure, leading to an attenuation, as function of distance, lower than free space. The performance in terms of crosstalk is slightly worsened, since the worst-case crosstalk is equal to  $-11.8 \text{ dB}$ . Similar results were achieved also for the  $3 \times 3$  OWIB in the multilayered medium.



**Fig. 9.** Transmittance in dB as a function of the wavelength, calculated by 3D-FDTD simulation, at the receiving OPAs, i.e.  $Rx_0$ , and  $Rx_{\pm 1}$ , and  $Rx_{\pm 2}$  with taper length  $L_T=2$   $\mu\text{m}$ , antenna distance  $d = \frac{2\lambda}{n_U V_{26}}$ , and link distance  $d_{link} = 55$   $\mu\text{m}$ . The phase shift at the transmitting and at the receiving OPAs are, respectively: (a)  $\alpha=0^\circ$ ,  $\alpha_{Rx0,\pm 1,\pm 2}=0^\circ$ ; (b)  $\alpha=120^\circ$ ,  $\alpha_{Rx+1}=-120^\circ$ ,  $\alpha_{Rx0,-1,\pm 2}=0^\circ$ , (c)  $\alpha=120^\circ$ ,  $\alpha_{Rx-2}=-120^\circ$ ,  $\alpha_{Rx0,\pm 1,\pm 2}=0^\circ$ , (d)  $\alpha=-120^\circ$ ,  $\alpha_{Rx-1}=120^\circ$ ,  $\alpha_{Rx0,+1,\pm 2}=0^\circ$ , (e)  $\alpha=-120^\circ$ ,  $\alpha_{Rx+2}=120^\circ$ ,  $\alpha_{Rx0,\pm 1,-2}=0^\circ$ . The simulations are performed considering the propagation in the multilayered medium of Fig. 8(a).

Owing to the wireless propagation, insertion losses are not negligible. To overcome this problem, different approaches are possible. As described above, by increasing the number of antennas, the gain of the OPA can be raised (e.g. with 3 antennas the maximum gain is 21 dB, whereas for 5 antennas it is 25 dB). Moreover, the maximum gain can be also improved by increasing the directivity of the antenna elements in the OPAs by using directors or lateral gratings [32,33,22,28]. More complex optimization procedures such as particle-swarm optimization can be also applied to design the antenna geometrical parameters [34,35].

A further way of improving this device with respect to the insertion losses is related to the engineering of the wireless channel characteristics. As shown by the results, the propagation in the multilayered on-chip medium can lead to a significant reduction of the insertion losses (e.g. reduction of 8 dB in the reported examples), provided the optimized design of the OWIB and of the propagation medium (e.g. by the choice of the cladding materials and of the thickness of the layers).

It is worth pointing out that, as Fig. 9 shows, the variation of the transmittance spectra with the wavelength is very limited, thus guaranteeing broadband operation, that can largely include the complete C-band.

To maintain this broadband feature, it is very important to realize wideband phase shifters, avoiding the use of resonant structures. To this purpose, phase shifters based on thermo-optic or plasma-optic effects could be used. For example, considering the results reported in [36], a phase shift of  $120^\circ$  can be obtained, in a SOI waveguide, by thermo-optic effect with a 320  $\mu\text{m}$ -long OPS. The estimated heater power, necessary for phase-shifting, is of about 15 mW. For the connection of one transmitter and one receiver in the OWIB, the phase-shift the OPAs would require roughly 60 mW.

The main benefit of the proposed OWIB is the large bandwidth when compared to MRR resonators. For example, if a WDM signal is used for communication, with channel spacing

$\Delta\lambda=0.8$  nm virtually about 120 channels can be allocated in the simulated 100-nm bandwidth of the OWIB. Given the broadband behavior of the OWIB, the power required for signal routing is independent from the number of WDM channels. Therefore, it is apparent that the proposed device performances are more attractive when the number of channels scales up.

Conversely, in MRR-based networks, the power required for routing would grow with the number of channels owing to the increased number of resonators necessary for communication (e.g. about 2-mW power is needed for thermo-optic switching of a single MRR [37] and about 20  $\mu$ W per MRR are required for resonance tuning [38]).

As a counterpart, propagation losses tend to be higher for wireless propagation with respect to MRR based networks [39–42]. Considering insertion losses, the OWIB concept becomes competitive when the number of MRR, required for routing a large number of WDM channels, increases (e.g. typically, insertion losses for a single MRR are 2 dB in the on-state and about 0.9 dB for a MRR in the off-state [40]).

The fabrication process necessary to realize the proposed antenna arrays involve very well-established and robust fabrication steps for a SOI platform. The taper antenna, considered as a passive non-tunable structure, can be realized through patterning of the SOI sample through deep-submicron precision Electron Beam Lithography (EBL). Such a powerful tool is particularly suitable for the realization of the nanometric scale dielectric antennas. At this stage, some issues can arise from the resist layer deposited over the waveguides. Indeed, if the taper becomes very narrow (e.g., 200 nm or less) the resist polymer, due to its low density, encounters problem in keeping firm above the taper shape, with the risk of spreading over a larger surface, thus compromising the precision in the following etching process. To circumvent this problem, a secondary, auxiliary pattern is written in the EBL process, that allows sustaining the resist layer, preventing it from spreading. After the EBL patterning, Reactive Ion Etching (RIE) is required for the realization of the antennas and the waveguide; in the same process, the auxiliary pattern is canceled. A planarized dielectric cladding can be deposited through Plasma-Enhanced Chemical Vapour Deposition (PECVD), to cover the antenna layer. Moreover, in order to realize the electrodes for thermal tuning of the antenna arrays, the deposition of high-quality metallic layers can be performed through evaporation and lift-off techniques.

For guaranteeing their correct execution, all the fabrication steps can be checked and validated through several metrology techniques, such as Ellipsometry and Scanning Electron Microscopy (SEM). However, any unlikely significant impairment on the waveguides or electrodes size due to fabrication imperfections that could impact on the OPA performance can in principle be compensated by an opportune network calibration.

#### 4. Conclusion

In this paper, we have proposed the design of Optical Wireless Interconnection Blocks based on OPAs for on-chip communications between multiple transmitters and receivers. The design criteria of the OPAs have been identified and the performances of  $1 \times 3$ ,  $1 \times 5$ , and  $3 \times 3$  switching matrices have been evaluated by 3D-FDTD simulations. The effect of multipath propagation in the on-chip multilayered medium was also analyzed, showing that an improvement of the insertion loss of about 8 dB can be achieved by optimized design. Considering the proposed device to be realized in integrated silicon photonics technology, it can guarantee a broadband behavior that allows a very good scalability in terms of WDM channels, and a consequent increase of the energy per bit efficiency.

Assuming chip-scale interconnection as the main target application for the proposed device, the non-resonant nature of the proposed system, exploiting broadband antennas, can lead to a reduction of the overall amount of MRRs in the network (being the use of these components necessary only as modulators and not as switching elements), to an improvement of the overall power budget, and to the possibility of switching multiple wavelengths on a single OPA. We

expect the proposed optical wireless technology to substantially cut down on the number of instantiated MRRs, on the static power overhead, and on the signal-to-noise ratio over guided photonics for chip-scale connectivity, which would pave the way for a new class of densely integrated chips better equipped to tackle the daunting challenge of massive-scale data processing.

**Disclosures.** The authors declare no conflicts of interest.

**Data availability.** Data underlying the results presented in this paper are not publicly available at this time but may be obtained from the authors upon reasonable request.

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